

Part Number: 877822202

Product Description: 0.60mm Pitch miniDIMM Socket, Surface Mount, Vertical, 2.5V Voltage Key, 200 Circuits, 0.76µm Gold (Au) Plating, Off-White Latches, without Pickand-Place Cap, Lead-Free

Status: Active

Series Number: 87782

Product Category: Memory Module

Connectors

Documents & Resources

Drawings

Drawing 877822202_sd.pdf Packaging Design Drawing PK-87782-003-001.pdf

3D Models and Design Files

3D Model 877822202_stp.zip

Electrical Model Document EE-87782-001-001.pdf Electrical Model Document EE-87782-002-001.pdf Electrical Model Document EE-87782-003-001.pdf Electrical Model Document EE-87782-007-001.pdf S-Parameter Model SP-87782-001-001.zip S-Parameter Model SP-87782-007-001.zip

Specifications

Application Specification AS-87782-001-001.pdf Product Specification PS-87782-027-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	©
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2- 21
REACH SVHC	Not Contained per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	Memory Module Connectors
Series	87782
Description	0.60mm Pitch miniDIMM Socket, Surface Mount, Vertical, 2.5V Voltage Key, 200 Circuits, 0.76µm Gold (Au) Plating, Off-White Latches, without Pick-and-Place Cap, Lead-Free
Component Type	Socket
JEDEC Outline	MO-258
Product Family	MiniDIMM Sockets
Product Name	MiniDIMM
UPC	822348683864

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage Key	2.5V
Voltage - Maximum	30V (RMS)

Physical

Circuits (Loaded)	200
Circuits (maximum)	200
Durability (mating cycles max)	25
Entry Angle	Vertical (Top Entry)
Flammability	94V-0
Housing Color	Black
Keying to Mating Part	Yes
Latch Color	Natural (Off-White)
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	5.555/g
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	0.60mm
Pitch - Termination Interface	0.60mm
Plating min - Mating	0.762µm
Plating min - Termination	2.540µm
Temperature Range - Operating	-55° to +85°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	5
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	2
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Mates With	JEDEC MO-258 Modules

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